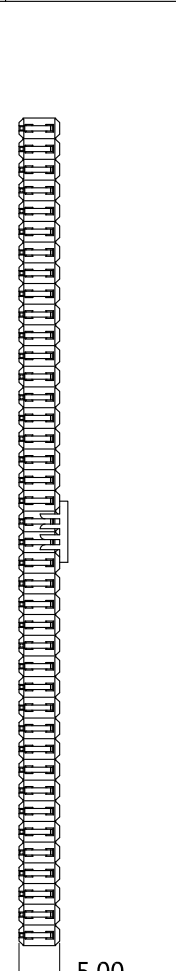
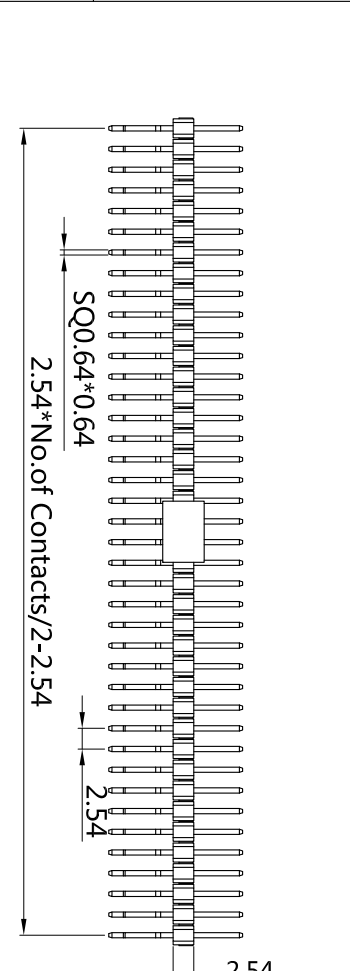
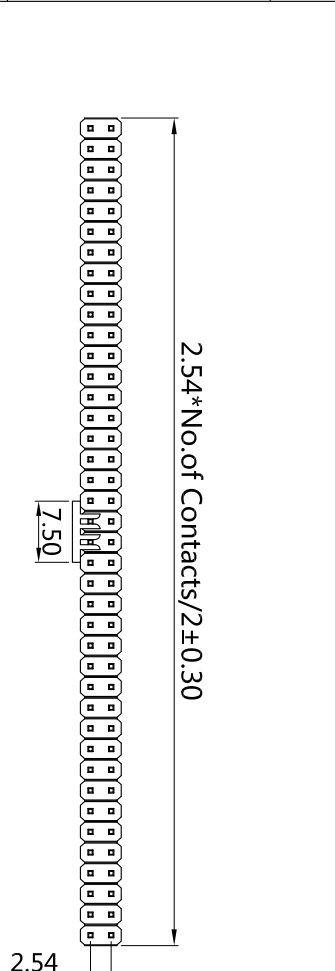


A



E
(RoHS Compliant)

H1 XX25- 2 XX DS BK X 002 E
1 2 3 4 5 6 7

1. Insulator materials:
N=PA6T P=PA9T
L=LCP Y=Bright Tin over Nickel
2. Circuits:02-40P1N
3. Tail Style:
DS=R/S SMD
4. Color:
BK=Black

5. Contact Plated:
T=Matte Tin over Nickel
W=Matte Tin over nickel 150µm
Y=Bright Tin over Nickel

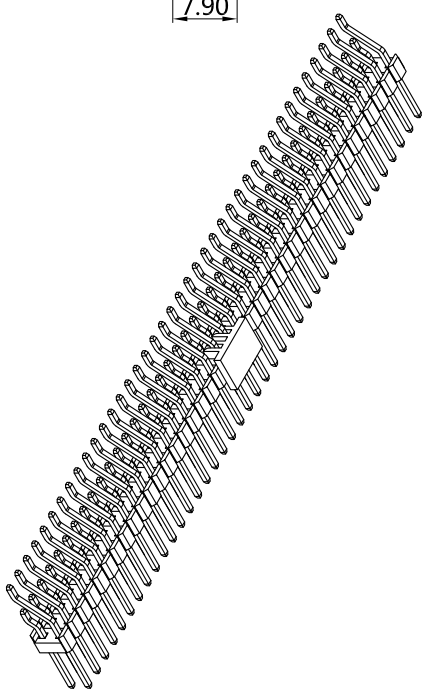
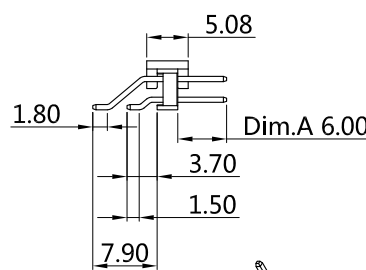
6. Special Options

7. Packing:
A=Bag
B=Tube
C=Tray

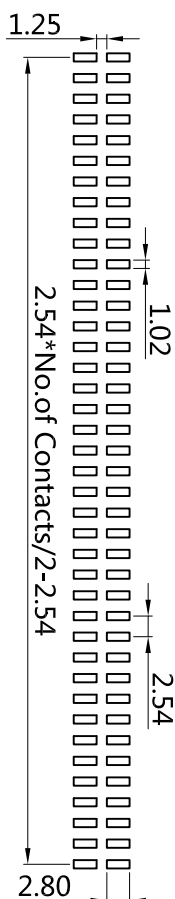
E=Gold 5µm, Matte Tin 100µm
G=Gold 10µm, Matte Tin 100µm
J=Gold 10µm, Matte Tin 100µm
L=Gold 15µm, Matte Tin 100µm
M=Gold 15µm, Matte Tin 100µm
U=Gold 30µm, Matte Tin 100µm
V=Gold 30µm, Matte Tin 100µm

A

Current Rating: 3 Amps
Insulator Resistance: 1000 Megohms min
Dielectric Withstanding: 500V AC
Contact Resistance: 20mΩ MAX
Operation Temperature: -40~+105°C
Max processing temp: 230°C for 60seconds
Max processing temp: 260°C for 10seconds
Contact Material: Brass
Insulator material: Polyester UL 94V-0
Standard: PA6T
Finish: Tin, Gold Plated
Standard: Gold Flash all over



**Recommended P.C. Board
SMT Layout**



<p>东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p>		PART NO.		H1X25-2XXDSBKX002E		X		.XX		.XXX	
BOM		1:1H1X25-240BKHO1		DRAWING NO		ZS-10329-P		EDITION: A1		ITEM: H1	
TEL:0769-85305015 FAX:0769-85845060		2:SQ0.64-12.4/17.9-X-C12		DRAWN BY		Deng jin quan		2020-6-24		SCALE:1:1	
		3:HN-CAP-H1-C4		APPROVAL BY		Chen xiao guang		2020-6-24		UNIT:M.M	